

LTC 1458/LTC 1458L

Quad 12-Bit Rail-to-Rail Micropower DACs

The LTC[®]1458/LTC1458L are complete single supply,

guad rail-to-rail voltage output, 12-bit digital-to-analog

converters (DACs) in SO-28 and SSOP-28 packages. They

include an output buffer amplifier with variable gain ($\times 1$ or

 \times 2) and an easy-to-use 3-wire cascadable serial interface.

The LTC1458 has an onboard reference of 2.048V and a

full-scale output of 4.095V in a $\times 2$ gain configuration. It

operates from a single 4.5V to 5.5V supply dissipating

The LTC1458L has an onboard 1.22V reference and a full-

scale output of 2.5V in a \times 2 gain configuration. It operates

from a single supply of 2.7V to 5.5V dissipating 2.4mW.

Excellent DNL, low supply current and a wide range of built-in functions allow these parts to be used in a host of

applications when flexibility, power and single supply

T, LTC and LT are registered trademarks of Linear Technology Corporation.

DESCRIPTION

only 5.5 mW ($I_{CC} = 1.1 \text{mA typ}$).

operation are important.

FEATURES

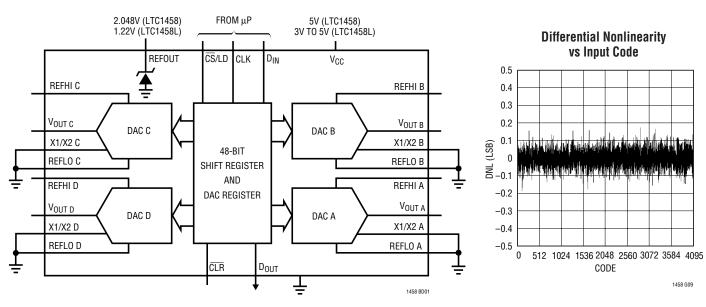
- Quad 12-Bit DAC
- Buffered True Rail-to-Rail Voltage Output
- Maximum DNL Error: 0.5LSB
- 5V Operation, I_{CC}: 1.1mA Typ (LTC1458)
- 3V Operation, I_{CC}: 800µA Typ (LTC1458L)
- Internal or External Reference Operation
- Settling Time: 14µs to ±0.5LSB
- Schmitt Trigger On Clock Input Allows Direct Optocoupler Interface
- Power-On Reset and CLR Pin
- SSOP-28 Package
- 3-Wire Cascadable Serial Interface with 250kHz Update Rate
- Low Cost

APPLICATIONS

- Digital Calibration
- Industrial Process Control
- Automatic Test Equipment
- Low Power Systems

TYPICAL APPLICATION

Functional Block Diagram: Quad 12-Bit Rail-to-Rail DAC

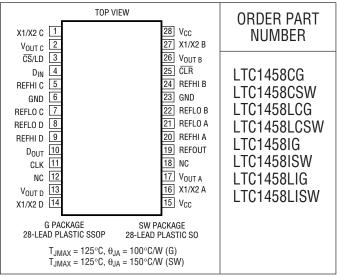




ABSOLUTE MAXIMUM RATINGS

V_{CC} to GND
V _{OUT A} , V _{OUT B} , V _{OUT C} , V _{OUT D} ,
X1/X2 A, X1/X2 B, X1/X2 C,
, , , ,
X1/X2 D $-0.5V$ to V _{CC} + 0.5V
REFHI A, REFHI B, REFHI C, REFHI D,
REFLO A, REFLO B, REFLO C,
REFLO D $-0.5V$ to V _{CC} + 0.5V
Maximum Junction Temperature 125°C
Operating Temperature Range
LTC1458C/LTC1458LC0°C to 70°C
LTC1458I/LTC1458LI40°C to 85°C
Storage Temperature Range65°C to 150°C
Lead Temperature (Soldering, 10 sec) 300°C

PACKAGE/ORDER INFORMATION



Consult factory for Military grade parts.

ELECTRICAL CHARACTERISTICS The • denotes the specifications which apply over the full operating

temperature range, otherwise specifications are at $T_A = T_{MIN}$ to T_{MAX} . $V_{CC} = 4.5V$ to 5.5V (LTC1458), 2.7V to 5.5V (LTC1458L), X1/X2 = REFLO = GND, REFHI = REFOUT, V_{OUT} unloaded, unless otherwise noted.

SYMBOL	PARAMETER	CONDITIONS		MIN	TYP	MAX	UNITS
DAC	I	1	I				
	Resolution			12			Bits
DNL	Differential Nonlinearity	Guaranteed Monotonic (Note 2)				±0.5	LSB
INL	Integral Nonlinearity	T _A = 25°C (Note 2)	•		±1.75 ±2.25	±4.0 ±4.5	LSB LSB
V _{OS}	Offset Error	T _A = 25°C	•		±3.0 ±6.0	±12 ±18	mV mV
V _{OS} TC	Offset Error Temperature Coefficient				±15		μV/°C
V _{FS}	Full-Scale Voltage	When Using Internal Reference, LTC1458, T _A = 25°C LTC1458	•	4.065 4.045	4.095 4.095	4.125 4.145	V V
		When Using Internal Reference, LTC1458L, $T_A = 25^{\circ}C$ LTC1458L	•	2.470 2.460	2.500 2.500	2.530 2.540	V V
V _{FS} TC	Full-Scale Voltage Temperature Coefficient	When Using Internal Reference			±24		ppm/°C
Reference	e						
	Reference Output Voltage	LTC1458 LTC1458L	•	2.008 1.195	2.048 1.220	2.088 1.245	V V
	Reference Output Temperature Coefficient				±20		ppm/°C
	Reference Line Regulation				0.7	±2.0	LSB/V
	Reference Load Regulation	$0 \le I_{OUT} \le 100 \mu A$, LTC1458 LTC1458L	•		0.2 0.6	1.5 3.0	LSB LSB
	Reference Input Range	$V_{\text{REFHI}} \le V_{\text{CC}} - 1.5V$			$V_{CC}/2$		V
	Reference Input Resistance			15	24	40	kΩ



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SYMBOL	PARAMETER	CONDITIONS		MIN	ТҮР	MAX	UNITS
	Reference Input Capacitance				15		pF
	Short-Circuit Current	REFOUT Shorted to GND	•		45	120	mA
Power Su	pply		• •				
V _{CC}	Positive Supply Voltage	For Specified Performance, LTC1458 LTC1458L	•	4.5 2.7		5.5 5.5	V V
I _{CC}	Supply Current	$4.5V \leq V_{CC} \leq 5.5V$ (Note 5) , LTC1458 $2.7V \leq V_{CC} \leq 5.5V$ (Note 5), LTC1458L	•		1100 800	2400 2000	μΑ μΑ
Op Amp D	C Performance		· · ·				
	Short-Circuit Current Low	V _{OUT} Shorted to GND	•		60	120	mA
	Short-Circuit Current High	V _{OUT} Shorted to V _{CC}	•		70	120	mA
	Output Impedance to GND	Input Code = 0	•		40	160	Ω
AC Perfor	mance						
	Voltage Output Slew Rate	(Note 3)	•	0.5	1.0		V/µs
	Voltage Output Settling Time	(Notes 3, 4) to ±0.5LSB			14		μs
	Digital Feedthrough				0.3		nV∙s
	AC Feedthrough	REFHI = 1kHz, 2V _{P-P} , (Code: All 0s)			-95		dB
SINAD	Signal-to-Noise + Distortion	REFHI = 1kHz, 2V _{P-P} , (Code: All 1s)			85		dB

The • denotes the specifications which apply over the full operating temperature range, otherwise specifications are at $T_A = T_{MIN}$ to T_{MAX} . $V_{CC} = 5V$ (LTC1458), 3V (LTC1458L), unless otherwise noted.

					LTC1458			LTC1458L		
SYMBOL	PARAMETER	CONDITIONS		MIN	ТҮР	MAX	MIN	ТҮР	MAX	UNITS
Digital I/O										
V _{IH}	Digital Input High Voltage		•	2.4			2.0			V
V _{IL}	Digital Input Low Voltage		•			0.8			0.6	V
V _{OH}	Digital Output High Voltage	I _{OUT} = -1mA	•	V _{CC} -1.0			V _{CC} - 0.7			V
V _{OL}	Digital Output Low Voltage	I _{OUT} = 1mA	•			0.4			0.4	V
I _{LEAK}	Digital Input Leakage	$V_{IN} = GND$ to V_{CC}	•			±10			±10	μA
C _{IN}	Digital Input Capacitance	Guaranteed by Design, Not Subject to Test	•			10			10	pF
Switching										
t ₁	D _{IN} Valid to CLK Setup			40			60			ns
t ₂	D _{IN} Valid to CLK Hold		•	0			0			ns
t ₃	CLK High Time		•	40			60			ns
t ₄	CLK Low Time		•	40			60			ns
t ₅	CS/LD Pulse Width		•	50			80			ns
t ₆	LSB CLK to CS/LD		•	40			60			ns
t ₇	CS/LD Low to CLK		•	20			30			ns
t ₈	D _{OUT} Output Delay	C _{LOAD} = 15pF	•			150			220	ns
t9	CLK Low to CS/LD Low		•	20			30			ns



ELECTRICAL CHARACTERISTICS

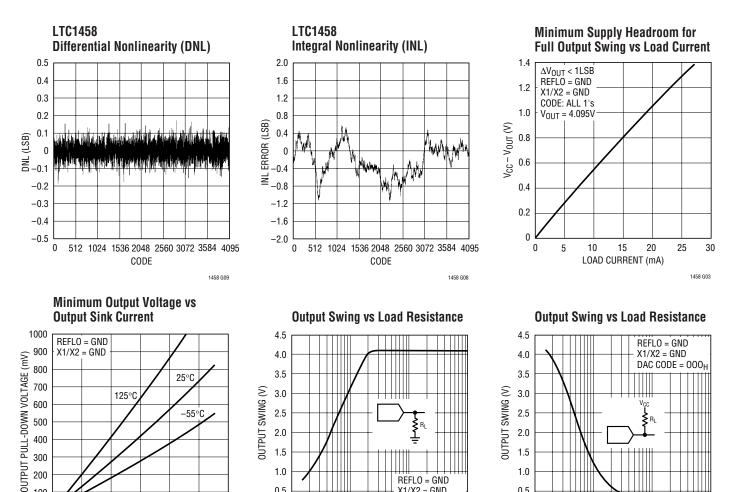
Note 1: Absolute Maximum Ratings are those values beyond which the life of a device may be impaired.

Note 2: Nonlinearity is defined from the first code that is greater than or equal to the maximum offset specification to code 4095 (full scale).

Note 3: Load is $5k\Omega$ in parallel with 100pF. Note 4: DAC switched between all 1s and the code corresponding to $V_{\mbox{OS}}$ for the part.

Note 5: Digital inputs at OV or V_{CC}.

TYPICAL PERFORMANCE CHARACTERISTICS



REFLO = GND

X1/X2 = GNDDAC CODE = FFF_H

10k

1458 G05A

1k

0.5

0

10

100



100

0.1

0

5

10

15

OUTPUT SINK CURRENT (mA)

20

www.BDTIC.com/Linear

0.5

25

30

1458 G04

0

10

100

LOAD RESISTANCE (Ω)



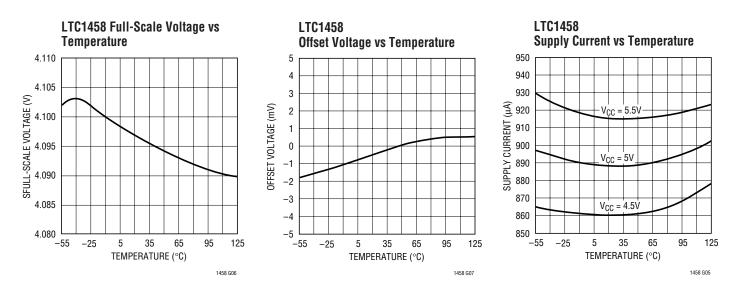
1k

LOAD RESISTANCE (Ω)

10k

1458 G06A

TYPICAL PERFORMANCE CHARACTERISTICS



PIN FUNCTIONS

X1/X2 C, X1/X2 D,X1/X2 A, X1/X2 B (Pins 1, 14, 16, 27): The Input Pin that Sets the Gain for DAC C/D/A/B. When grounded the gain will be 2, i.e., output full-scale will be $2 \cdot \text{REFHI}$. When connected to V_{OUT} the gain will be 1, i.e., output full-scale will be equal to REFHI.

V_{OUT C}, V_{OUT D}, V_{OUT A}, V_{OUT B} (Pins 2, 13, 17, 26): The Buffered DAC Outputs.

CS/LD (Pin 3): The Serial Interface Enable and Load Control Input.

DIN (Pin 4): The Serial Data Input.

REFHI C, REFHI D, REFHI A, REFHI B, (Pins 5, 9, 20, 24): The Inputs to the DAC Resistor Ladder for DAC C/D/A/B.

GND (Pins 6, 23): Ground.

REFLO C, REFLO D, REFLO A, REFLO B, (Pins 7, 8, 21, 22): The Bottom of the DAC Resistor Ladders for the DACs. These can be used to offset zero-scale above ground. REFLO should be connected to ground when no offset is required.

D_{OUT} (**Pin 10**): The Output of the Shift Register which Becomes Valid on the Rising Edge of the Serial Clock.

CLK (Pin 11): The Serial Interface Clock Input.

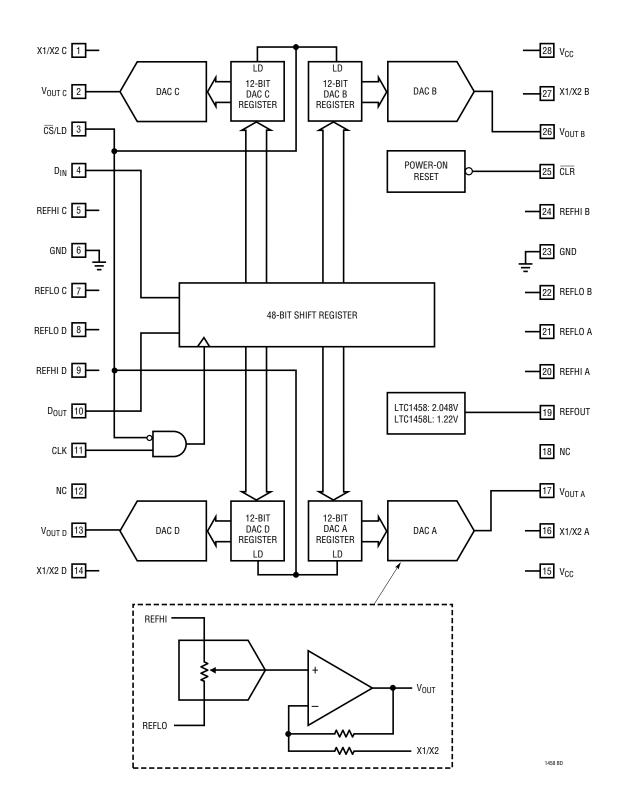
 V_{CC} (Pins 15, 28): The Positive Supply Input. 4.5V \leq V_{CC} \leq 5.5V (LTC1458), 2.7V \leq V_{CC} \leq 5.5V (LTC1458L). Requires a 0.1µF bypass capacitor to ground.

REFOUT (Pin 19): The Output of the Internal Reference.

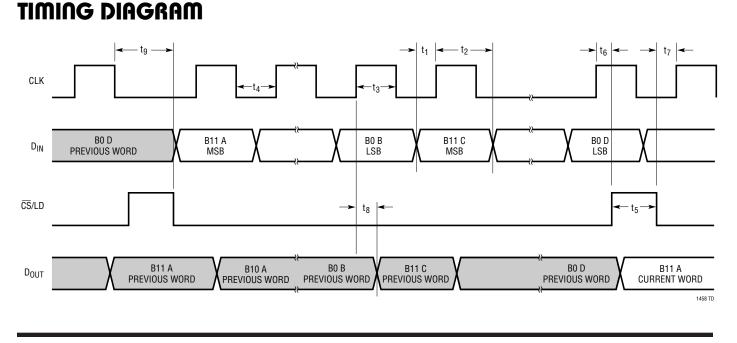
CLR (Pin 25): The Clear Pin. Clears all DACs to zero-scale when pulled low.



BLOCK DIAGRAM







DEFINITIONS

Resolution (n): Resolution is defined as the number of digital input bits, n. It defines the number of DAC output states (2ⁿ) that divide the full-scale range. The resolution does not imply linearity.

Full-Scale Voltage (V_{FS}): This is the output of the DAC when all bits are set to 1.

Voltage Offset Error (V_{OS}): The theoretical voltage at the output when the DAC is loaded with all zeros. The output amplifier can have a true negative offset, but because the part is operated from a single supply, the output cannot go below zero. If the offset is negative, the output will remain near OV resulting in the transfer curve shown in Figure 1.

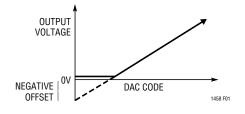


Figure 1. Effect of Negative Offset

The offset of the part is measured at the code that corresponds to the maximum offset specification:

 $V_{OS} = V_{OUT} - [(Code)(V_{FS})/(2^n - 1)]$

Least Significant Bit (LSB): One LSB is the ideal voltage difference between two successive codes.

$$LSB = (V_{FS} - V_{OS})/(2^n - 1) = (V_{FS} - V_{OS})/4095$$

Nominal LSBs:

LTC1458 LSB = 4.095V/4095 = 1mV LTC1458L LSB = 2.5V/4095 = 0.610mV

Integral Nonlinearity (INL): End-point INL is the maximum deviation from a straight line passing through the end-points of the DAC transfer curve. Because the part operates from a single supply and the output cannot go below zero, the linearity is measured between full scale and the code corresponding to the maximum offset specification. The INL error at a given input code is calculated as follows:

- $INL = [V_{OUT} V_{OS} (V_{FS} V_{OS})(code/4095)]/LSB$
- V_{OUT} = The output voltage of the DAC measured at the given input code



DEFINITIONS

Differential Nonlinearity (DNL): DNL is the difference between the measured change and the ideal 1LSB change between any two adjacent codes. The DNL error between any two codes is calculated as follows:

 $DNL = (\Delta V_{OUT} - LSB)/LSB$

 ΔV_{OUT} = The measured voltage difference between two adjacent codes

Digital Feedthrough: The glitch that appears at the analog output caused by AC coupling from the digital inputs when they change state. The area of the glitch is specified in (nV)(sec).

OPERATION

Serial Interface

The data on the D_{IN} input is loaded into the shift register on the rising edge of the clock. Data is loaded as one 48-bit word, DAC A first, then DAC B, DAC C and DAC D. The MSB is loaded first for each DAC. The DAC registers load the data from the shift register when \overline{CS}/LD is pulled high. The CLK is disabled internally when \overline{CS}/LD is high. Note: CLK must be low before \overline{CS}/LD is pulled low to avoid an extra internal clock pulse.

The buffered output of the 48-bit shift register is available on the D_{OUT} pin which swings from ground to $V_{CC}.$

Multiple LTC1458/LTC1458Ls may be daisy-chained together by connecting the D_{OUT} pin to the D_{IN} pin of the next chip, while the CLK and \overline{CS} /LD signals remain common to all chips in the daisy-chain. The serial data is clocked to all of the chips, then the \overline{CS} /LD signal is pulled high to update all of them simultaneously.

Reference

The LTC1458L has an internal reference of 1.22V with a full scale of 2.5V (gain of 2 configuration). The LTC1458 includes an internal 2.048V reference, making 1LSB equal to 1mV (gain of 2 configuration). When the buffer gain is 2, the external reference must be less than $V_{CC}/2$ and be capable of driving the 15k minimum DAC resistor ladder. The external reference must always be less than $V_{CC} - 1.5V$. The reference output voltage noise spectral density at 1kHz is $300nV/\sqrt{Hz}$.

Voltage Output

The rail-to-rail buffered output of the LTC1458 family can source or sink 5mA when operating with a 5V supply over the entire operating temperature range while pulling to within 300mV of the positive supply voltage or ground. The output swings to within a few millivolts of either supply rail when unloaded and has an equivalent output resistance of 40 Ω when driving a load to the rails. The output can drive 1000pF without going into oscillation. The output voltage noise spectral density at 1kHz is 600nV/ \sqrt{Hz} .

APPLICATIONS INFORMATION

Using Two DACs to Digitally Program the Full Scale and Offset of a Third

Figure 2 shows how to use one LTC1458 to make a 12-bit DAC with a digitally programmable full scale and offset. DAC A and DAC B are used to control the offset and full scale of DAC C. DAC A is connected in a \times 1 configuration and controls the offset of DAC C by moving REFLO C above ground. The minimum value to which this offset can be programmed is 10mV. DAC B is connected in a \times 2 configuration and controls the full scale of DAC C by driving REFHI C. Note that the voltage at REFHI C must be less than or equal to V_{CC}/2, corresponding to DAC B's code

 \leq 2,500 for V_{CC} = 5V, since DAC C is being operated in \times 2 mode for full rail-to-rail output swing.

The transfer characteristic is:

 $V_{OUTC} = 2 \bullet [D_C \bullet (2 \bullet D_B - D_A) + D_A] \bullet REFOUT$

where REFOUT = The Reference Output

 $D_A = (DAC \ A \ Digital \ Code)/4096$ This sets the offset.

 $D_B = (DAC B Digital Code)/4096$ This sets the full scale.

 $D_C = (DAC \ C \ Digital \ Code)/4096$

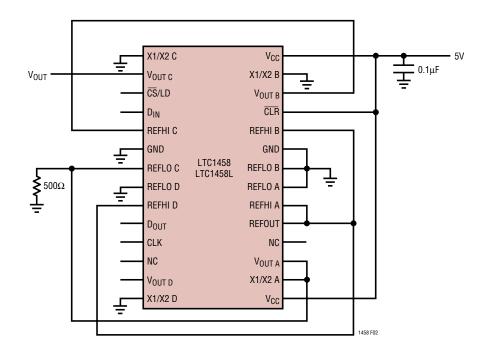
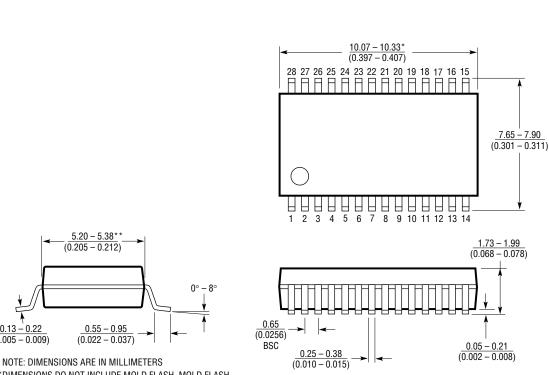


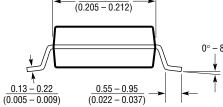
Figure 2



PACKAGE DESCRIPTION Dimensions in inches (millimeters) unless otherwise noted.



G Package 28-Lead Plastic SŠOP (0.209) (LTC DWG # 05-08-1640)



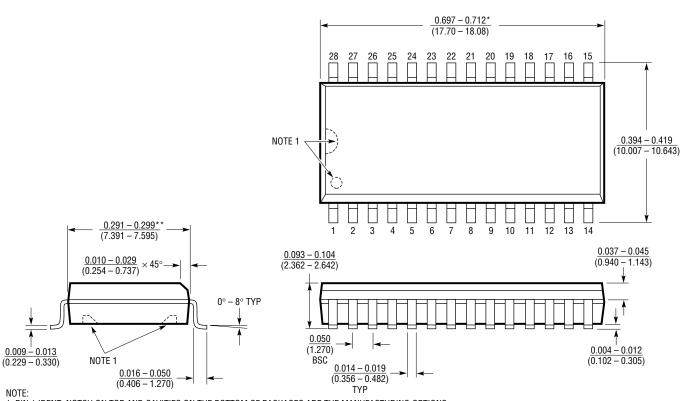
*DIMENSIONS DO NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.152mm (0.006") PER SIDE

**DIMENSIONS DO NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.254mm (0.010") PER SIDE

G28 SSOP 1098



PACKAGE DESCRIPTION Dimensions in inches (millimeters) unless otherwise noted.



SW Package 28-Lead Plastic Small Outline (Wide 0.300) (LTC DWG # 05-08-1620)

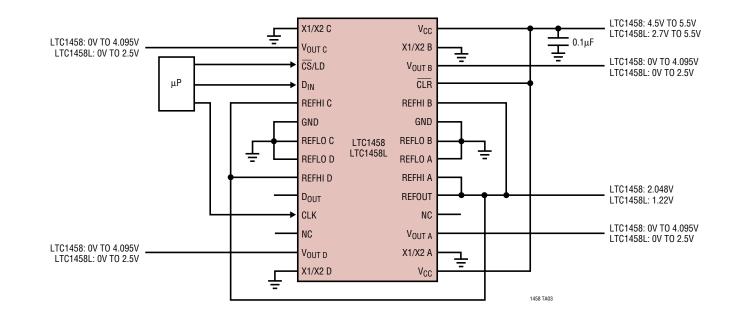
1. PIN 1 IDENT, NOTCH ON TOP AND CAVITIES ON THE BOTTOM OF PACKAGES ARE THE MANUFACTURING OPTIONS. THE PART MAY BE SUPPLIED WITH OR WITHOUT ANY OF THE OPTIONS

*DIMENSION DOES NOT INCLUDE MOLD FLASH. MOLD FLASH SHALL NOT EXCEED 0.006" (0.152mm) PER SIDE

**DIMENSION DOES NOT INCLUDE INTERLEAD FLASH. INTERLEAD FLASH SHALL NOT EXCEED 0.010" (0.254mm) PER SIDE



TYPICAL APPLICATION



RELATED PARTS

PART NUMBER	DESCRIPTION	COMMENTS
LTC1257	Single 12-Bit V_{OUT} DAC, Full Scale: 2.048V, V_{CC} : 4.75V to 15.75V, Reference Can Be Overdriven up to 12V, i.e., FS _{MAX} = 12V	5V to 15V Single Supply, Complete V _{OUT} DAC in SO-8 Package
LTC1446/LTC1446L	Dual 12-Bit Rail-to-Rail Output DACs in SO-8 Package	LTC1446: V_{CC} = 4.5V to 5.5V, V_{OUT} = 0V to 4.095V LTC1446L: V_{CC} = 2.7V to 5.5V, V_{OUT} = 0V to 2.5V
LTC1450/LTC1450L	Single 12-Bit Rail-to-Rail Output DACs with Parallel Interface	LTC1450: $V_{CC} = 4.5V$ to 5.5V, $V_{OUT} = 0V$ to 4.095V LTC1450L: $V_{CC} = 2.7V$ to 5.5V, $V_{OUT} = 0V$ to 2.5V
LTC1451	Single Rail-to-Rail 12-Bit DAC, Full Scale: 4.095V, V _{CC} : 4.5V to 5.5V	Low Power, Complete V _{OUT} DAC in SO-8 Package
LTC1452	Single Rail-to-Rail 12-Bit V_{OUT} Multiplying DAC, V_{CC} : 2.7V to 5.5V	Low Power, Multiplying V _{OUT} DAC with Rail-to-Rail Buffer Amplifier in SO-8 Package
LTC1453	Single Rail-to-Rail 12-Bit V_{OUT} DAC, Full Scale: 2.5V, V_{CC} : 2.7V to 5.5V	3V, Low Power, Complete V _{OUT} DAC in SO-8 Package
LTC1454/LTC1454L	Dual 12-Bit $V_{\mbox{OUT}}$ DACs in SO-16 Package with Added Functionality	LTC1454: $V_{CC} = 4.5V$ to 5.5V, $V_{OUT} = 0V$ to 4.095V LTC1454L: $V_{CC} = 2.7V$ to 5.5V, $V_{OUT} = 0V$ to 2.5V
LTC1456	Single Rail-to-Rail Output 12-Bit DAC with Clear Pin, Full Scale: 4.095V, V _{CC} : 4.5V to 5.5V	Low Power, Complete V _{OUT} DAC in SO-8 Package with Clear Pin
LTC1655/LTC1655L	Single 16-Bit V_{OUT} DAC with Serial Interface in SO-8	$V_{CC} = 5V (3V)$, Low Power, Deglitched, $V_{OUT} = 0V \text{ to } 4.096V (0V \text{ to } 2.5V)$
LTC1661	Dual 10-Bit V _{OUT} DAC in 8-Lead MSOP Package	V _{CC} = 2.7V to 5.5V Micropower, Rail-to-Rail Output
LTC1662	Ultralow Power, Dual 10-Bit DAC in 8-Lead MSOP Package	1.5µA I _{CC} per DAC, 2.7V to 5.5V Supply Range
LTC1664	Quad 10-Bit V _{OUT} DAC in 16-Pin Narrow SSOP	Pin Compatible with the LTC1660, 2.7V to 5.5V Supply Range
LTC1665/LTC1660	Octal 8/10-Bit V _{OUT} DAC in 16-Pin Narrow SSOP	V _{CC} = 2.7V to 5.5V, Micropower, Rail-to-Rail Output

